TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

# SSM6N15FE

#### High Speed Switching Applications Analog Switching Applications

- Small package
- Low ON resistance  $: R_{on} = 4.0 \Omega \text{ (max)} (@V_{GS} = 4 \text{ V})$  $: R_{on} = 7.0 \Omega \text{ (max)} (@V_{GS} = 2.5 \text{ V})$

#### Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

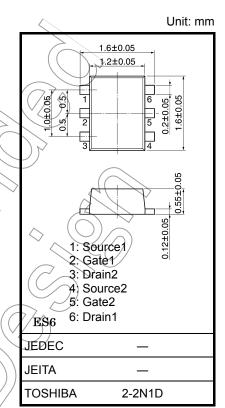
Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DS</sub>	30	$\sim$	
Gate-Source voltage		V <sub>GSS</sub>	±20		
Drain current	DC	I <sub>D</sub>	100	(mA)	
	Pulse	I <sub>DP</sub>	200		
Drain power dissipation (Ta = $25^{\circ}$ C)		P <sub>D</sub> (Note 1)	150	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

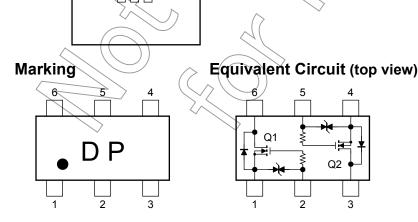
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating, mounted on FR4 board (25.4 mm × 25.4 mm × 1.6/t, Cu Pad: 0.135 mm × 6)

0.3 mm



Weight: 3mg (typ.)



#### **Handling Precaution**

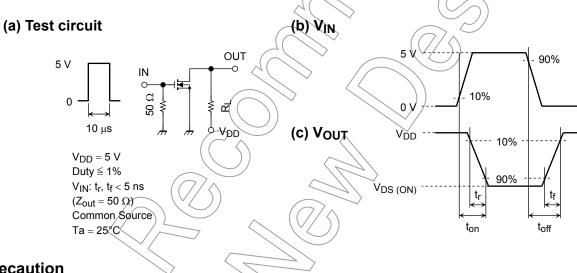
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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#### Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 16~V,~V_{DS}=0$			±1	μA	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	30		_	V	
Drain cut-off current		I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0$	_		1	μA	
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = 3 \text{ V}, \text{ I}_{D} = 0.1 \text{ mA}$	0.8		1.5	V	
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = 3 \text{ V}, \text{ I}_{D} = 10 \text{ mA}$	25	) /~(		mS	
Drain-Source ON resistance		R <sub>DS (ON)</sub>	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$		2.2	4.0		
			$I_{\rm D}$ = 10 mA, $V_{\rm GS}$ = 2.5 V	$\bigcirc$	4.0	7.0	Ω	
Input capacitance		C <sub>iss</sub>			7.8		pF	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 3 V, V_{GS} = 0, f = 1 MHz$		3.6		pF	
Output capacitance		C <sub>OSS</sub>			8.8		pF	
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 10 \text{ mA},$		50	$\rightarrow$		
	Turn-off time	t <sub>off</sub>	V <sub>GS</sub> = 0~5 V	-6	180	> -	ns	

## Switching Time Test Circuit



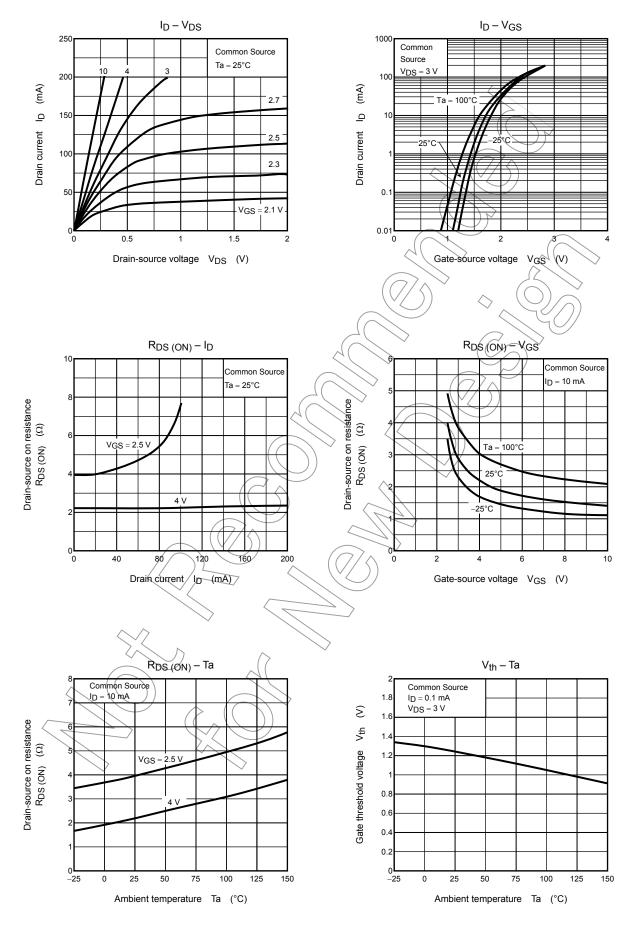
#### Precaution

 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D = 100 \ \mu A$  for this product. For normal switching operation, VGS (on) requires higher voltage than Vth and VGS (off) requires lower voltage than  $V_{th}$ . Relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on) )

Please take this into consideration for using the device.

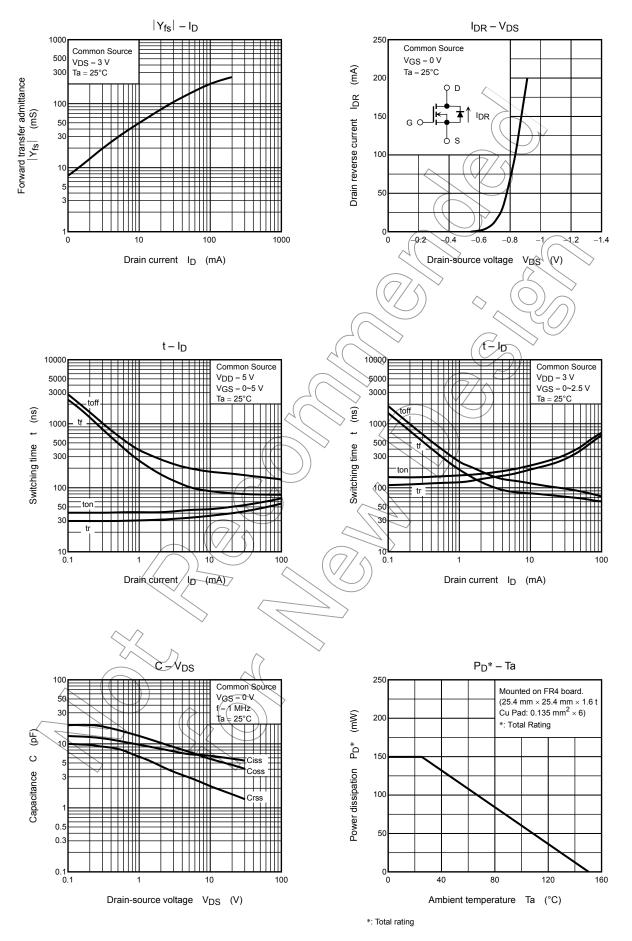
# **TOSHIBA**

# (Q1, Q2 Common)



# TOSHIBA

## (Q1, Q2 Common)



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